



Product Change Notification

Change Notification #: 114318 - 01

Change Title: Intel® SSD 530 Series (80GB, 120GB, 2.5in SATA 6Gb/s, 20nm, MLC) 7mm, Reseller 5 Pack, Intel® SSD 530 Series (80GB, 180GB, 2.5in SATA 6Gb/s, 20nm, MLC) 7mm, Generic 50 Pack, Intel® SSD 530 Series (120GB, 180GB, 240GB, 480GB, 2.5in SATA 6Gb/s, 20nm, MLC) 7mm, Generic Single Pack, Intel® SSD 530 Series (120GB, 240GB, M.2 80mm SATA 6Gb/s, 20nm, MLC) Dual Sided, Generic Single Pack, Intel® SSD 530 Series (120GB, M.2 42mm SATA 6Gb/s, 20nm, MLC) Dual Sided, Generic Single Pack, Intel® SSD 530 Series (80GB, 120GB, 180GB, 240GB, PCIe Module mSATA 6Gb/s, 20nm, MLC) 4.85mm, Generic Single Pack, Intel® SSD 530 Series (180GB, PCIe Module mSATA 6Gb/s, 20nm, MLC) 4.85mm, Generic 50 Pack, Intel® SSD 530 Series (120GB, 240GB, PCIe Module mSATA 6Gb/s, 20nm, MLC) 4.85mm, Generic 100 Pack, Intel® SSD 535 Series (120GB, 180GB, 240GB, 360GB, 480GB, 2.5in SATA 6Gb/s, 16nm, MLC) 7mm, Reseller 5 Pack, Intel® SSD 535 Series (56GB, 120GB, 128GB, 180GB, 240GB, 256GB, 360GB, 480GB, 512GB, 2.5in SATA 6Gb/s, 16nm, MLC) 7mm, Generic 50 Pack, Intel® SSD 535 Series (56GB, 120GB, 128GB, 180GB, 240GB, 256GB, 360GB, 480GB, 512GB, 2.5in SATA 6Gb/s, 16nm, MLC) 7mm, Generic Single Pack, Intel® SSD 535 Series (120GB, 180GB, 240GB, 360GB, M.2 80mm SATA 6Gb/s, 16nm, MLC) Generic Single Pack, Intel® SSD 535 Series (120GB, 180GB, 240GB, 360GB, M.2 80mm SATA 6Gb/s, 16nm, MLC) Generic 100 Pack,

Intel® SSD Pro 1500 Series (120GB, 180GB, 240GB, 480GB, 2.5in SATA 6Gb/s, 20nm, MLC) 7mm, Generic Single Pack,
Intel® SSD Pro 2500 Series (180GB, 240GB, 360GB, M.2 80mm SATA 6Gb/s, 16nm, MLC) Generic 100 Pack,
Intel® SSD Pro 2500 Series (180GB, 240GB, 360GB, M.2 80mm SATA 6Gb/s, 16nm, MLC) Generic Single Pack,
Intel® SSD Pro 2500 Series (120GB, 180GB, 240GB, 480GB, 360GB, 2.5in SATA 6Gb/s, 20nm, MLC) 7mm, Generic 50 Pack,
Intel® SSD Pro 2500 Series (120GB, 180GB, 240GB, 360GB, 480GB, 2.5in SATA 6Gb/s, 20nm, MLC) 7mm, Generic Single Pack,
Intel® SSD Pro 2500 Series (120GB, PCIe Module mSATA 6Gb/s, 20nm, MLC) 4.85mm, Generic 100 Pack,
Intel® SSD Pro 2500 Series (120GB, PCIe Module mSATA 6Gb/s, 20nm, MLC) 4.85mm, Generic Single Pack,
PCN 114318-01, Label, Transport Media Label and Box Graphics Update
[Reason for Revision: Customer Impact of Change Update](#)

Date of Publication: January 14, 2016

Key Characteristics of the Change:

Label, Transport Media

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Jan 22, 2016
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[Reason for Revision: Customer Impact of Change and Recommended Action Update](#)

Description of Change to the Customer:

The Intel® SSD 530 Series, Intel® SSD 535 Series, Intel® SSD Pro 1500 Series and Intel® SSD Pro 2500 Series SKUs listed in the Products Affected table below will have the following Australia Regulatory Mark Change:

The Australian Communications and Media Authority's (ACMA) labeling arrangements to reflect

- Regulatory compliance changed on 1 March 2013, to be phased in over a three-year transition period. Products shipping March 1, 2016 need to be labeled with the "RCM" mark.
- Per ACMA requirements, Intel will be changing the C-Tick regulatory mark on all products to the "RCM" mark.

Current Generic Intel® SSD Series 2.5 Labels

Intel® SSD XXXX Series **XXXGB**
FW: XXXX

SA: XXXXXX-XXX
PBA: XXXXXX-XXX
LBA XXX,XXX,XXX
Pb-free 2LI

Intel Corporation
Attn: Corporate Quality
2200 Mission College Blvd.
Santa Clara, CA 95054-1549
USA WO: XXXXXXXX

CAN ICES-3(B)/NMB-3(B) WWN: XXXXXXXXXXXXXXXX
Model: SSDXXXXXXXXXX
2.5" XGb/s SATA SSD XXXG XV X.XA

Disclaimer: WARRANTY VOID IF ANY LABEL/
SCREW IS REMOVED OR BROKEN

PSID: XXXXXXXXXXXXXXXX
XXXXXXXXXXXXXXXXXX

Designed in USA, assembled in China.

New Generic Intel® SSD Series 2.5 Labels

Intel® SSD XXXX Series **XXXGB**
FW: XXXX

SA: XXXXXX-XXX
PBA: XXXXXX-XXX
LBA XXX,XXX,XXX
Pb-free 2LI

Intel Corporation
Attn: Corporate Quality
2200 Mission College Blvd.
Santa Clara, CA 95054-1549
USA WO: XXXXXXXX

CAN ICES-3(B)/NMB-3(B) WWN: XXXXXXXXXXXXXXXX
Model: SSDXXXXXXXXXX
2.5" XGb/s SATA SSD XXXG XV X.XA

Disclaimer: WARRANTY VOID IF ANY LABEL/
SCREW IS REMOVED OR BROKEN

PSID: XXXXXXXXXXXXXXXX
XXXXXXXXXXXXXXXXXX

Designed in USA, assembled in China.

   CAN ICES-3(B)/NMB-3(B)
KCC-REM-CPU-SSDSA2X

Current Generic Intel® SSD Pro Series 2.5 Labels:



New Generic Intel® SSD Pro Series 2.5 Labels:



Current Generic Intel® SSD Pro Series 2.5 Labels: No Opal



Opal



New Generic Intel® SSD Pro Series 2.5 Labels: No Opal

Intel® SSD XXX Series **XXXGB**
FW: XXXX



SA: XXXXXX-XXX
PBA: XXXXXX-XXX
LBA XXX,XXX,XXX
Pb-free 2LI

Intel Corporation
Attn: Corporate Quality
2200 Mission College Blvd.
Santa Clara, CA 95054-1549
USA WO: XXXXXXXX

Model: SSDXXXXXXXXXX WWN: XXXXXXXXXXXXXXXX
2.5" XGb/s SATA SSD XXXG XV X.XA

Disclaimer: WARRANTY VOID IF ANY LABEL/
SCREW IS REMOVED OR BROKEN



Designed in USA, assembled in China.

SERIAL ATA VCI KC CAN ICES-3(B)/NMB-3(B)
MSIP-REM-CPU-SSDSA2Y

CE D33025 E139761 20



Opal

Intel® SSD Pro XXXX Series **XXXGB**
FW: XXXX



SA: XXXXXX-XXX
PBA: XXXXXX-XXX
LBA XXX,XXX,XXX
Pb-free 2LI

Intel Corporation
Attn: Corporate Quality
2200 Mission College Blvd.
Santa Clara, CA 95054-1549
USA WO: XXXXXXXX

Model: SSDXXXXXXXXXX WWN: XXXXXXXXXXXXXXXX
2.5" XGb/s SATA SSD XXXG XV X.XA

Disclaimer: WARRANTY VOID IF ANY LABEL/
SCREW IS REMOVED OR BROKEN



PSID: XXXXXXXXXXXXXXXX
XXXXXXXXXXXXXXXXXX

Designed in USA, assembled in China.

SERIAL ATA VCI KC CAN ICES-3(B)/NMB-3(B)
MSIP-REM-CPU-SSDSA2Y

CE D33025 E139761 20



Current Generic M.2 80MM label:

SN: VSPPYWWDXXXXNNNF FW: XXXX
Model: XXXXXXXXXXXXX Pb-free 2LI
SA: XXXXX-XXX
PBA: XXXXX-XXX LBA XX,XXX,XXX
Capacity: XXXGB www.intel.com
PSID: RATED DC X.XV X.XA
WWN: 5001517FFFFFFFF

ES1

WARRANTY VOID IF REMOVED
Designed in USA, assembled in China.



New Generic M.2 80MM label:

SN: VSPPYWWDXXXXNNNF FW: XXXX
Model: XXXXXXXXXXXXX Pb-free 2LI
SA: XXXXX-XXX
PBA: XXXXX-XXX LBA XX,XXX,XXX
Capacity: XXXGB www.intel.com
PSID: RATED DC X.XV X.XA
WWN: 5001517FFFFFFFF

ES1

WARRANTY VOID IF REMOVED
Designed in USA, assembled in China.



Current Generic Msata (Change impacted regulatory label only)

No Opal:


SN: VSPPYWWDXXXXNNNF FW: XXXX
Model: XXXXXXXXXXXXXXX Pb-free 2LI
SA: XXXXXX-XXX
PBA: XXXXXX-XXX LBA XX,XXX,XXX
Capacity: XXXGB www.intel.com
 RATED DC X.XV X.XA
WWN: 5001517FFFFFFFFF
ES1 
WARRANTY VOID IF REMOVED
Designed in USA, assembled in China.

Opal:


SN: VSPPYWWDXXXXNNNF FW: XXXX
Model: XXXXXXXXXXXXXXX Pb-free 2LI
SA: XXXXXX-XXX
PBA: XXXXXX-XXX LBA XX,XXX,XXX
Capacity: XXXGB www.intel.com
PSID:  RATED DC X.XV X.XA
WWN: 5001517FFFFFFFFF
ES1 
WARRANTY VOID IF REMOVED
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Current

   
D33025 CAN ICES-3(B)/NMB-3(B)
  
 SERIAL ATA 
E139761 KCC-REM-CPU-MSATA

New

   
D33025 CAN ICES-3(B)/NMB-3(B)
  
 SERIAL ATA 
E139761 KCC-REM-CPU-MSATA

Current Generic Msata (Change impacted regulatory label only):

SN: VSPPYWWDXXXXNNNF FW: XXXX
Model: SSDXXXXXXXXXX
SA: XXXXX-XXX
PBA: XXXXX-XXX
Capacity: XXXGB
PSID: XXXXXXXXXXXXXXXX
XXXXXXXXXXXXXXXXXX



ES1
WWN: 5001517FFFFFFFFF
WARRANTY VOID IF REMOVED

Designed in USA, assembled in China.
www.intel.com
RATED DC X.XV X.XA
LBA XXX,XXX,XXX
CAN ICES-3(B)/NMB-3(B)



D33025 20 MSP-REM-CPU-NGATA3

New Generic Msata (Change impacted regulatory label only):

SN: VSPPYWWDXXXXNNNF FW: XXXX
Model: SSDXXXXXXXXXX
SA: XXXXX-XXX
PBA: XXXXX-XXX
Capacity: XXXGB
PSID: XXXXXXXXXXXXXXXX
XXXXXXXXXXXXXXXXXX



ES1
WWN: 5001517FFFFFFFFF
WARRANTY VOID IF REMOVED

Designed in USA, assembled in China.
www.intel.com
RATED DC X.XV X.XA
LBA XXX,XXX,XXX
CAN ICES-3(B)/NMB-3(B)



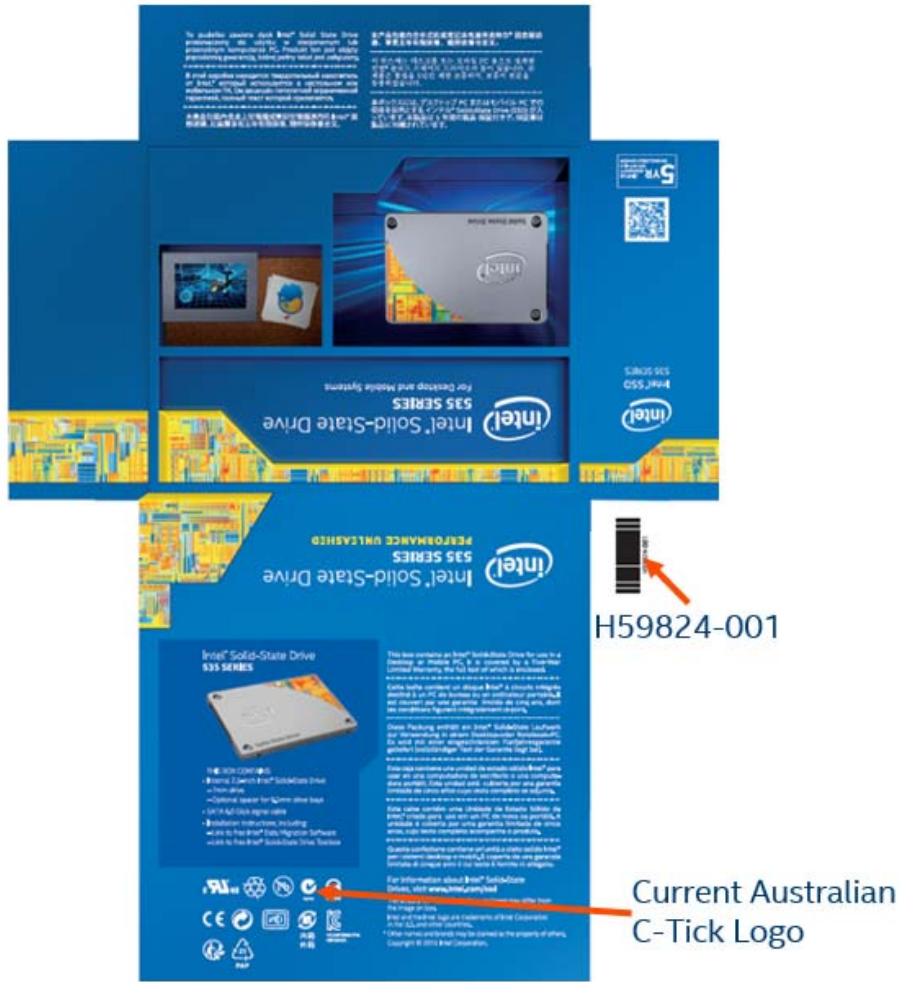
D33025 20 MSP-REM-CPU-NGATA3

The following skus have the following changes on the box:

MM#
940117
940118
940119
940120
940121

- The bar code number is changing from H59824-001 to H59824-002
 - Australian C-Tick logo change
 - California Proposition 65 verbiage added
- See box illustrations for details

Current Box:



New Box:



Customer Impact of Change and Recommended Action:

There is no change to the form, fit, or function of the product.

Customers should be aware of the changes to the label and take appropriate actions to accommodate the changes and avoid impact to their process.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#
SSDSCKHW240A401	927679
SSDMCEAW180A4	927687
SSDMCEAW180A401	927688
SSDMCEAW240A4	927691
SSDMCEAW240A401	929066
SSDSC2BF180A401	929416
SSDSC2BF240A401	929417
SSDSC2BF480A401	929419
SSDSC2BW240A401	929421
SSDSC2BW180A401	929425
SSDSC2BW480A401	929426
SSDSCKHW120A401	929842
SSDMCEAW120A4	929846
SSDMCEAW120A401	929847
SSDSC2BW120A4K5	929865
SSDSC2BW120A401	929868
SSDSC2BF120A401	929869
SSDMCEAW080A401	929912
SSDSC2BW080A4	929921
SSDSC2BW080A4K5	930327
SSDSCIHW120A401	930362
SSDSC2BW180A4	930913
SSDSC2BF120H5	933945
SSDSC2BF180H5	933946
SSDSC2BF240H5	933947
SSDSC2BF360H5	933948
SSDSC2BF480H5	933950
SSDSC2BF120H501	933959
SSDSC2BF180H501	933961
SSDSC2BF240H501	933962
SSDSC2BF360H501	933963
SSDSC2BF480H501	933964
SSDSC2BW120H601	939476
SSDSC2BW180H601	939477
SSDSC2BW240H601	939478
SSDSC2BW360H601	939479
SSDSC2BW480H601	939480
SSDSC2BW120H6	939481
SSDSC2BW180H6	939482
SSDSC2BW240H6	939483
SSDSC2BW360H6	939484
SSDSC2BW480H6	939485
SSDSC2BW120H6R5	940117
SSDSC2BW180H6R5	940118
SSDSC2BW240H6R5	940119
SSDSC2BW360H6R5	940120
SSDSC2BW480H6R5	940121
SSDSCKJW180H601	940318
SSDSCKJW240H601	940319
SSDSCKJW360H601	940320

Product Code	MM#
SSDMCEAF120A501	941405
SSDMCEAF120A5	941406
SSDSCKJW120H601	941928
SSDSCKJW120H6	941930
SSDSCKJW180H6	942381
SSDSCKJW240H6	942382
SSDSCKJW360H6	942383
SSDSCKJF180H601	943023
SSDSCKJF180H6	943024
SSDSCKJF240H601	943025
SSDSCKJF240H6	943026
SSDSCKJF360H601	943027
SSDSCKJF360H6	943028
SSDSC2BW056H601	944688
SSDSC2BW056H6	944689
SSDSCKGW360H601	945674
SSDSC2BW128H601	947422
SSDSC2BW128H6	947423
SSDSC2BW256H601	947424
SSDSC2BW256H6	947425
SSDSC2BW512H601	947426
SSDSC2BW512H6	947427

PCN Revision History:

Date of Revision:

January 8, 2016

January 14, 2016

Revision Number:

00

01

Reason:

Originally Published PCN

Customer Impact of Change
Update



Product Change Notification

114318 - 01

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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